

SNOSAO8A – DECEMBER 2010 – REVISED MARCH 2013

LF442QML Dual Low Power JFET Input Operational Amplifier

Check for Samples: LF442QML

FEATURES

- 1/10 Supply Current of a LM1458: 400 μA (Max)
- Low Input Bias Current: 50 pA (Typ)
- Low Input Offset Voltage: 1 mV (Typ)
- Low Input Offset Voltage Drift: 7 μV/°C (Typ)
- High Gain Bandwidth: 1 MHz (Typ)
- High Slew Rate: 1 V/µs (Typ)
- Low Noise Voltage for Low Power: 35 nV/√Hz (Typ)
- Low Input Noise Current: 0.01 pA/ $\sqrt{\text{Hz}}$ (Typ)
- High Input Impedance: 10¹²Ω

Typical Connection



DESCRIPTION

The LF442 dual low power operational amplifier provides many of the same AC characteristics as the industry standard LM1458 while greatly improving the DC characteristics of the LM1458. The amplifier has the same bandwidth, slew rate, and gain (10 k Ω load) as the LM1458 and only draws one tenth the supply current of the LM1458. In addition the well matched high voltage JFET input devices of the LF442 reduce the input bias and offset currents by a factor of 10,000 over the LM1458. A combination of careful layout design and internal trimming ensures very low input offset voltage and voltage drift. The LF442 also has a very low equivalent input noise voltage for a low power amplifier.

The LF442 is pin compatible with the LM1458 allowing an immediate 10 times reduction in power drain in many applications. The LF442 should be used where low power dissipation and good electrical characteristics are the major considerations.

Connection Diagram



Pin 4 connected to case

Figure 1. Top View TO-99 Package See Package Number LMC SNOSAO8A – DECEMBER 2010 – REVISED MARCH 2013



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Simplified Schematic



Detailed Schematic

Figure 3. 1/2 Dual





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings⁽¹⁾

| Supply Voltage | ±18V | | | | | |
|--|--------------------------------|--------------------|---------|--|--|--|
| Differential Input Voltage | ±30V | | | | | |
| Input Voltage Range ⁽²⁾ | ±15V | | | | | |
| Output Short Circuit Duration ⁽³⁾ | Continuous | | | | | |
| Maximum Power Dissipation ⁽⁴⁾ | 900mW | | | | | |
| T _J max | 150°C | | | | | |
| | 0 | Still Air | 161°C/W | | | |
| Thermal Resistance | OJA | 500LF/Min Air flow | 87°C/W | | | |
| | θ _{JC} | θ _{JC} | | | | |
| Operating Temperature Range | −55°C ≤ $T_A ≤ 125°C$ | | | | | |
| Storage Temperature Range | −65°C ≤ T _A ≤ 150°C | | | | | |
| Lead Temperature (Soldering, 10 sec | 260°C | | | | | |
| ESD Tolerance ⁽⁵⁾ | 500V | | | | | |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

(2) Unless otherwise specified the absolute maximum negative input voltage is equal to the negative power supply voltage.

(3) Any of the amplifier outputs can be shorted to ground indefinitely, however, more than one should not be simultaneously shorted as the maximum junction temperature will be exceeded.

(4) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.

(5) Human Body Model, 100pF discharged through $1.5K\Omega$

Quality Conformance Inspection

Table 1. Mil-Std-883, Method 5005 - Group A

| Subgroup | Description | Temp (°C) |
|----------|---------------------|-----------|
| 1 | Static tests at | +25 |
| 2 | Static tests at | +125 |
| 3 | Static tests at | -55 |
| 4 | Dynamic tests at | +25 |
| 5 | Dynamic tests at | +125 |
| 6 | Dynamic tests at | -55 |
| 7 | Functional tests at | +25 |
| 8A | Functional tests at | +125 |
| 8B | Functional tests at | -55 |
| 9 | Switching tests at | +25 |
| 10 | Switching tests at | +125 |
| 11 | Switching tests at | -55 |
| 12 | Settling time at | +25 |
| 13 | Settling time at | +125 |
| 14 | Settling time at | -55 |

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STRUMENTS

EXAS

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LF442 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. $V_S = \pm 15V$, $V_{CM} = 0V$, $R_S = 0\Omega$

| Symbol | Parameter | Conditions Notes Min Max U | | Unit | Sub- groups | | |
|-----------------------------|------------------------------------|---|---------------------|-------|----------------|------|---------|
| I _{CC} | Supply Current | | | | 500 | μA | 1, 2, 3 |
| N | Input Offcot Voltago | P - 10KO | | -5.0 | 5.0 | mV | 1 |
| V IO | input Onset voltage | $R_{\rm S} = 10R\Omega$ | | -7.5 | 7.5 | mV | 2, 3 |
| | Input Rice Current | | | | 0.1 | nA | 1 |
| ±ιB | Input bias Current | | | | 20 | nA | 2 |
| | Input Offeet Current | | | -0.05 | 0.05 | nA | 1 |
| 10 | input Onset Current | | | -10 | 10 | nA | 2 |
| CMRR | Common Mode Rejection Ratio | $V_{CM} = \pm 11V, R_{S} = 10K$ | | 70 | | dB | 1, 2, 3 |
| PSRR | Dower Supply Dejection Datio | $V_{S}^{+} = +15V \text{ to } +6V,$ $V_{S}^{-} = -15V$ | | 70 | | dB | 1, 2, 3 |
| | Power Supply Rejection Ratio | V_{S}^{-} = -15V to -6V, V_{S}^{+} = +15V | | 70 | | dB | 1, 2, 3 |
| | | $V_0 = 0V \text{ to } +10V,$ | Sec. ⁽¹⁾ | 25 | | V/mV | 4 |
| +A _{VS} | Large Signal Voltage Gain | $R_L = 10K\Omega$ | See | 15 | | V/mV | 5, 6 |
| | | $V_{O} = 0V$ to -10V, | Sec ⁽¹⁾ | 25 | | V/mV | 4 |
| -A _{VS} | Large Signal Voltage Gain | $R_L = 10K\Omega$ | See | 15 | | V/mV | 5, 6 |
| V _O ⁺ | Output Voltage Swing | $V_{I} = \pm 11V, R_{L} = 10K$ | | 12 | | V | 4, 5, 6 |
| V ₀ - | Output Voltage Swing | $V_{I} = \pm 11V, R_{L} = 10K$ | | | -12 | V | 4, 5, 6 |
| V _{CM} | Input Common Mode Voltage Range | | See ⁽²⁾ | 11 | -11 | V | 4, 5, 6 |

V/mV in units column is equivalent to K in datalog.
 Parameter tested go-no-go only, specified by CMRR test..

AC Parameters

The following conditions apply, unless otherwise specified. $V_S = \pm 15V$, $V_{CM} = 0V$, $R_S = 0\Omega$

| Symbol | Parameter | Conditions | Notes | Min | Max | Unit | Sub- groups |
|--------|-----------------|--|-------|-----|-----|------|----------------|
| SR⁺ | Slew Rate | V_{O} = -5V to +5V, A_{V} = 1, R _L = 2K Ω , C _L - 100pF | | 0.6 | | V/µS | 7 |
| SR | Slew Rate | $ \begin{array}{l} V_O = +5V \text{ to } -5V, \\ A_V = 1, \ R_L = 2K\Omega, \\ C_L - 100 p F \end{array} $ | | 0.6 | | V/µS | 7 |
| GBW | Gain Band Width | $V_{I} = 50 \text{mV}, f = 20 \text{KHz}$ | | 0.6 | | MHz | 7 |



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Figure 8.

TEXAS INSTRUMENTS

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Swing



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100

1k

FREQUENCY (Hz)

Figure 21.

10k

100k

TEXAS INSTRUMENTS

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APPLICATION HINTS

This device is a dual low power op amp with internally trimmed input offset voltages and JFET input devices (BI-FET II). These JFETs have large reverse breakdown voltages from gate to source and drain eliminating the need for clamps across the inputs. Therefore, large differential input voltages can easily be accommodated without a large increase in input current. The maximum differential input voltage is independent of the supply voltages. However, neither of the input voltages should be allowed to exceed the negative supply as this will cause large currents to flow which can result in a destroyed unit.

Exceeding the negative common-mode limit on either input will force the output to a high state, potentially causing a reversal of phase to the output. Exceeding the negative common-mode limit on both inputs will force the amplifier output to a high state. In neither case does a latch occur since raising the input back within the common-mode range again puts the input stage and thus the amplifier in a normal operating mode.

Exceeding the positive common-mode limit on a single input will not change the phase of the output; however, if both inputs exceed the limit, the output of the amplifier will be forced to a high state.

The amplifiers will operate with a common-mode input voltage equal to the positive supply; however, the gain bandwidth and slew rate may be decreased in this condition. When the negative common-mode voltage swings to within 3V of the negative supply, an increase in input offset voltage may occur.

Each amplifier is individually biased to allow normal circuit operation with power supplies of ± 3.0 V. Supply voltages less than these may degrade the common-mode rejection and restrict the output voltage swing.

The amplifiers will drive a 10 k Ω load resistance to ± 10V over the full temperature range.

Precautions should be taken to ensure that the power supply for the integrated circuit never becomes reversed in polarity or that the unit is not inadvertently installed backwards in a socket as an unlimited current surge through the resulting forward diode within the IC could cause fusing of the internal conductors and result in a destroyed unit.

As with most amplifiers, care should be taken with lead dress, component placement and supply decoupling in order to ensure stability. For example, resistors from the output to an input should be placed with the body close to the input to minimize "pick-up" and maximize the frequency of the feedback pole by minimizing the capacitance from the input to ground.

A feedback pole is created when the feedback around any amplifier is resistive. The parallel resistance and capacitance from the input of the device (usually the inverting input) to AC ground set the frequency of the pole. In many instances the frequency of this pole is much greater than the expected 3 dB frequency of the closed loop gain and consequenty there is negligible effect on stability margin. However, if the feedback pole is less than approximately 6 times the expected 3 dB frequency a lead capacitor should be placed from the output to the input of the op amp. The value of the added capacitor should be such that the RC time constant of this capacitor and the resistance it parallels is greater than or equal to the original feedback pole time constant.



LF442QML

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Typical Applications



Figure 25. Battery Powered Strip Chart Preamplifier

Runs from 9v batteries (±9V supplies)

Fully settable gain and time constant

Battery powered supply allows direct plug-in interface to strip chart recorder without common-mode problems

Figure 26. "No FET" Low Power V \rightarrow F Converter



Trim 1M pot for 1 kHz full-scale output 15 mW power drain No integrator reset FET required Mount D1 and D2 in close proximity 1% linearity to 1 kHz





Figure 27. High Efficiency Crystal Oven Controller

- T_{control}= 75°C
- A1's output represents the amplified difference between the LM335 temperature sensor and the crystal oven's temperature
- A2, a free running duty cycle modulator, drives the LM395 to complete a servo loop
- Switched mode operation yields high efficiency
- 1% metal film resistor





$$\begin{split} & E_{OUT} = - \left[\log 10 \left(\frac{E_{IN}}{R_{IN}} \right) + 5 \right] \\ & R_T = Tel \ Labs \ type \ Q81 \\ & Trim \ 5k \ for \ 10 \ \mu A \ through \ the \ 5k-120k \ combination \\ & *1\% \ film \ resistor \end{split}$$

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Figure 29. Unconventional Log Amplifier

Q1, Q2, Q3 are included on LM389 amplifier chip which is temperature-stabilized by the LM389 and Q2-Q3, which act as a heater-sensor pair.

Q1, the logging transistor, is thus immune to ambient temperature variation and requires no temperature compensation at all.

Table 2. Revision History

| Date Released | Revision | Section | Changes |
|---------------|----------|---------------------------------|---|
| 12/16/2010 | A | New release to corporate format | 1 MDS datasheet converted into one corporate datasheet format. MNLF442M-X Rev 0A1 will be archived. |
| 03/26/2013 | А | All Sections | Changed layout of National Data Sheet to TI format |



PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan | Lead finish/ | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|----------|--------------|---------|------|---------|----------|---------------|---------------|--------------|--|---------|
| | (1) | | Drawing | | Qty | (2) | Ball material | (3) | | (4/5) | |
| | | | | | | | (6) | | | | |
| LF442MH/883 | OBSOLETE | то-99 | LMC | 8 | | TBD | Call TI | Call TI | | LF442MH/883 5962-9763301QGA Q ACO 5962-9763301QGA Q >T | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OUTLINE

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



NOTES:

- 1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. Pin numbers shown for reference only. Numbers may not be marked on package.

- 4. Reference JEDEC registration MO-002/TO-99.



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EXAMPLE BOARD LAYOUT

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE





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